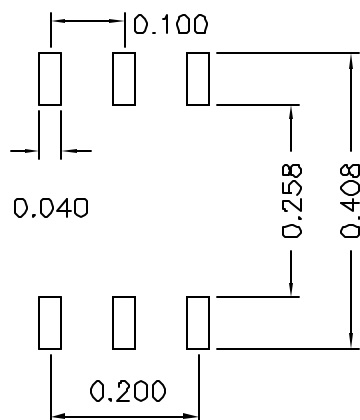
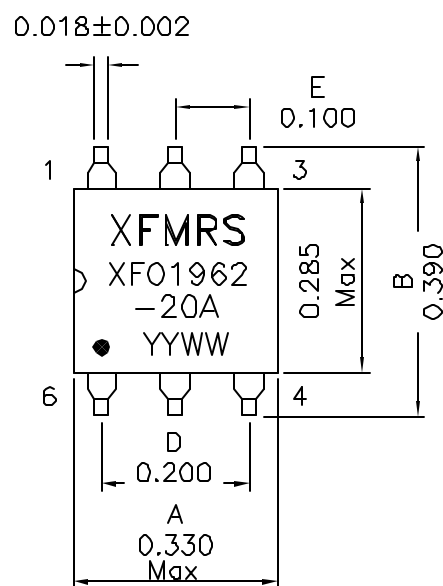
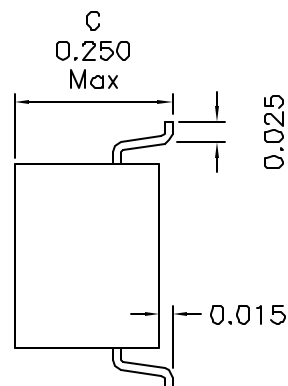


1. Mechanical Dimensions:



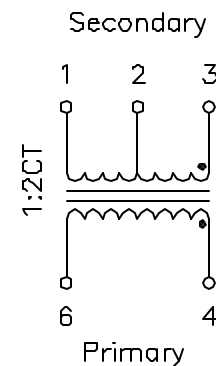
SUGGESTED PCB LAYOUT



Notes:

1. Solderability: Leads shall meet MIL-STD-202G, Method 208H for solderability.
2. Flammability: UL94V-0
3. ASTM oxygen index: > 28%
4. Insulation System: Class F 155°C. UL file E151556
5. Operating Temperature Range: All listed parameters are to be within tolerance from -40°C to +85°C
6. Storage Temperature Range: -55°C to +125°C
7. Aqueous wash compatible
8. SMD Lead Coplanarity: $\pm 0.004^{\circ}$ (0.102mm)
9. Electrical and mechanical specifications 100% tested
10. RoHS Compliant Component

2. Schematic:



3. Electrical Specifications:

OCL: Pins 4-6 19uH Min @100KHz 50mV

LL: Pins 4-6 0.2uH Max @1.0MHz 50mV, Short SEC

DCR: Pins 4-6 0.250 Ohms Max

DCR: Pins 3-1 0.300 Ohms Max

URNS RATIO: Pins (4-6):(3-2-1)=1:2CT $\pm$ 3%

HIPOT: 3000Vac, PRI to SEC

Designed to meet UL1950 supplementary insulation with 300 working volts

XFMRS Inc www.XFMRS.com		Title: T3/DS3/E3/STS-1 TRANSFORMERS		
UNLESS OTHERWISE SPECIFIED TOLERANCES: .xxx ± 0.010 Dimensions in INCH SHEET 1 OF 1	P/N: XFO1962-20A		REV. D	
	DWN.	Juan Mao	May-14-07	
	CHK.	YK Liao	May-14-07	
	APP.	MS	May-14-07	